

R07DS0763EJ0102

Rev.1.02

May. 28, 2013

# μ**PA2813T1L**

P-channel MOSFET

–30 V, –27 A, 6.2 mΩ

# Description

The  $\mu$ PA2813T1L is P-channel MOS Field Effect Transistor designed for DC/DC converter and power management applications of portable equipment.

### Features

- $V_{DSS} = -30 \text{ V} (T_A = 25^{\circ}\text{C})$
- Low on-state resistance
  - ----  $R_{DS(on)} = 6.2 \text{ m}\Omega \text{ MAX.} (V_{GS} = -10 \text{ V}, I_D = -27 \text{ A})$
- 4.5 V Gate-drive available
- Small & thin type surface mount package with heat spreader
- Pb-free and Halogen free



### **Ordering Information**

Part No.	Lead Plating	Packing	Package	
μΡΑ2813T1L-E2-AT <sup>*1</sup>	Pure Sn	Tape 3000 p/reel	8-pin HVSON (3333)	
		Tape 3000 p/Teel	typ. 0.028 g	

Note: \*1. Pb-free (This product does not contain Pb in external electrode and other parts.)

### Absolute Maximum Ratings (T<sub>A</sub> = 25°C)

Item	Symbol	Ratings	Unit
Drain to Source Voltage (V <sub>GS</sub> = 0 V)	V <sub>DSS</sub>	-30	V
Gate to Source Voltage (V <sub>DS</sub> = 0 V)	V <sub>GSS</sub>	<b>∓20</b>	V
Drain Current (DC) ( $T_c = 25^{\circ}C$ )	I <sub>D(DC)</sub>	<b>∓27</b>	A
Drain Current (pulse) *1	I <sub>D(pulse)</sub>	<b>∓108</b>	A
Total Power Dissipation *2	P <sub>T1</sub>	1.5	W
Total Power Dissipation (PW = 10 sec) *2	P <sub>T2</sub>	3.8	W
Total Power Dissipation ( $T_c = 25^{\circ}C$ )	P <sub>T3</sub>	52	W
Channel Temperature	T <sub>ch</sub>	150	٥C
Storage Temperature	T <sub>stg</sub>	-55 to +150	٥C
Single Avalanche Current *3	I <sub>AS</sub>	23	A
Single Avalanche Energy *3	E <sub>AS</sub>	54	mJ

# **Thermal Resistance**

Channel to Ambient Thermal Resistance *2	R <sub>th(ch-A)</sub>	83.3	°C/W
Channel to Case (Drain) Thermal Resistance	R <sub>th(ch-C)</sub>	2.4	°C/W

Notes: \*1. PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%

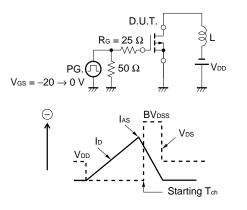
- \*2. Mounted on a glass epoxy board of 25.4 mm x 25.4 mm x 0.8 mmt
- \*3. Starting T<sub>ch</sub> = 25°C, V<sub>DD</sub> = –15 V, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = –20  $\rightarrow$  0 V, L = 100  $\mu$ H

# **Electrical Characteristics (T<sub>A</sub> = 25°C)**

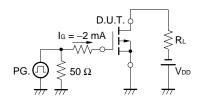
ltem	Symbol	MIN.	TYP.	MAX.	Unit	Test Conditions
Zero Gate Voltage Drain Current	I <sub>DSS</sub>			-1	μA	$V_{DS}$ = -30 V, $V_{GS}$ = 0 V
Gate Leakage Current	I <sub>GSS</sub>			<b>∓100</b>	nA	$V_{GS}$ = $\mp$ 20 V, $V_{DS}$ = 0 V
Gate Cut-off Voltage	V <sub>GS(off)</sub>	-1.0		-2.5	V	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ mA}$
Forward Transfer Admittance *1	y <sub>fs</sub>	8.0			S	$V_{DS}$ = -10 V, $I_{D}$ = -13.5 A
Drain to Source On-state	R <sub>DS(on)1</sub>		4.8	6.2	mΩ	$V_{GS}$ = -10 V, I <sub>D</sub> = -27 A
Resistance *1	R <sub>DS(on)2</sub>		9	13	mΩ	$V_{GS}$ = -4.5 V, I <sub>D</sub> = -13.5 A
Input Capacitance	C <sub>iss</sub>		3130		pF	$V_{DS} = -10 V,$
Output Capacitance	C <sub>oss</sub>		1490		pF	$V_{GS} = 0 V,$
Reverse Transfer Capacitance	C <sub>rss</sub>		1290		pF	f = 1 MHz
Turn-on Delay Time	t <sub>d(on)</sub>		16		ns	$V_{DD} = -15 \text{ V}, \text{ I}_{D} = -13.5 \text{ A},$
Rise Time	tr		41		ns	$V_{GS} = -10 V$ ,
Turn-off Delay Time	t <sub>d(off)</sub>		196		ns	R <sub>G</sub> = 10 Ω
Fall Time	t <sub>f</sub>		234		ns	
Total Gate Charge	Q <sub>G</sub>		80		nC	$V_{DD} = -24 V,$
Gate to Source Charge	Q <sub>GS</sub>		9		nC	$V_{GS} = -10 V,$
Gate to Drain Charge	Q <sub>GD</sub>		42		nC	I <sub>D</sub> = -27 A
Body Diode Forward Voltage *1	V <sub>F(S-D)</sub>		0.9		V	I <sub>F</sub> = 27 A, V <sub>GS</sub> = 0 V
Reverse Recovery Time	t <sub>rr</sub>		173		ns	I <sub>F</sub> = 27 A, V <sub>GS</sub> = 0 V,
Reverse Recovery Charge	Q <sub>rr</sub>		270		nC	di/dt = 100 A/µs

Note: \*1. Pulsed

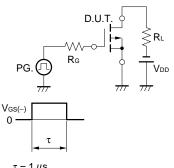
### TEST CIRCUIT 1 AVALANCHE CAPABILITY



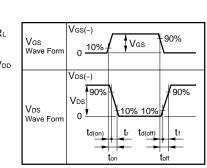
### TEST CIRCUIT 3 GATE CHARGE



### **TEST CIRCUIT 2 SWITCHING TIME**







# Typical Characteristics ( $T_A = 25^{\circ}C$ )

DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA 140 -1000 10 ms 100 ms PW = 200 μs dT - Percentage of Rated Power - % 120 -108 A -100 100 -27/ lo - Drain Current - A 80 -10 N05 60 -1 40 Single Pulse 20 -0.1 T<sub>A</sub> = 25°C Mounted on a glass epoxy board of 25.4 mm x 25.4 mm x 0.8 mmt 0 -0.01 0 75 100 125 25 50 150 175

TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

-0.01

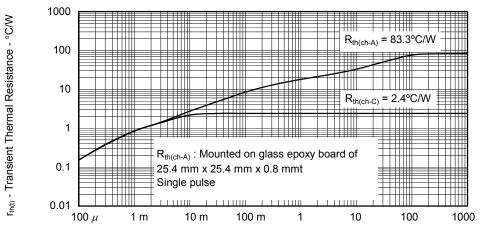
-0.1

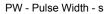
-1

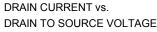
VDS - Drain to Source Voltage - V

-10

-100

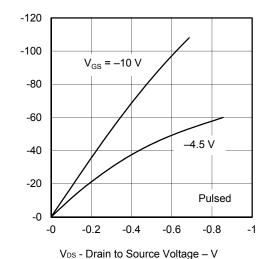


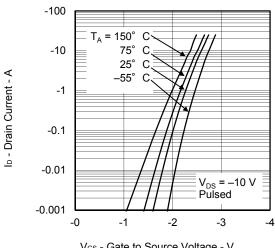




TA - Ambient Temperature - °C



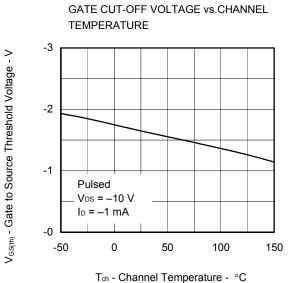




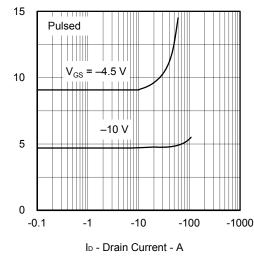
VGS - Gate to Source Voltage - V

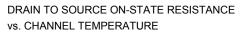
lo - Drain Current - A

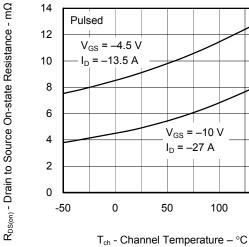


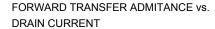


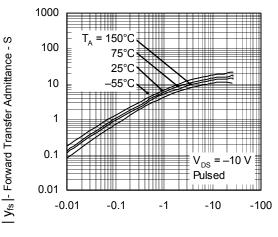
#### DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

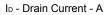




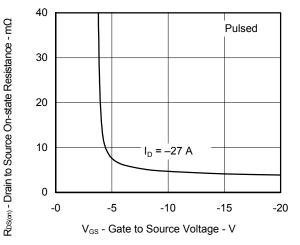




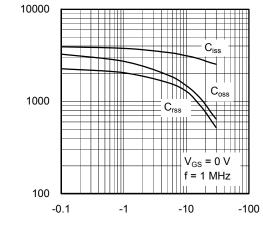




#### DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



### CAPACITANCE vs. DRAIN TOSOURCE VOLTAGE



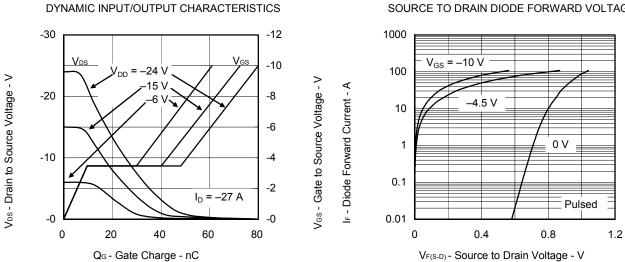
V<sub>DS</sub> - Drain to Source Voltage - V

 $R_{\text{DS(on)}}$  - Drain to Source On-state Resistance -  $m\Omega$ 

150

100

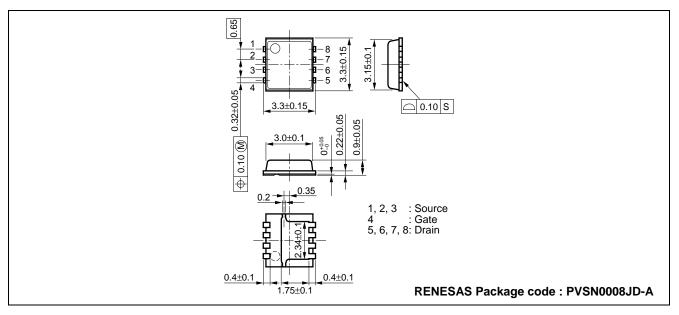
Ciss, Coss, Crss - Capacitance - pF



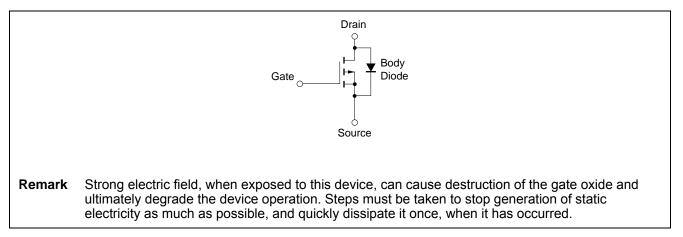
### SOURCE TO DRAIN DIODE FORWARD VOLTAGE

# Package Drawings (Unit: mm)

### 8-pin HVSON (3333)



## Equivalent Circuit





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